MFBM1V1005

Multilayer chip ferrite bead



Product features

- 0402 (1005 metric) package
- · High current handling
- Multilayer monolithic construction yields high reliability
- Impedance range from 0 Ω to 1000 Ω

Applications

- Industrial connectivity (IoT)
- Wireless communications
- Bluetooth
- WiFi
- Antennas
- Machine-to-machine (M2M)
- Mobile phones
- Wearable devices
- Wireless LAN
- Computing/gaming consoles
- Broadband components
- RF transceiver modules

Environmental compliance and general specifications

 Operating temperature range: -55 °C to +125 °C (ambient plus self-temperature rise)









Product specifications

Part number³	Impedance tolerance	Impedance (Ω)	DCR (Ω) maximum @ +25 °C	Test frequency ¹ (MHz)	Test voltage¹ (mV)	Rated current ² (mA) maximum
MFBM1V1005-000-R	0~15 Ω	0	0.05	100	50	1800
MFBM1V1005-050-R	0~15 Ω	5	0.05	100	50	1800
MFBM1V1005-070-R	0~11 Ω	7	0.05	100	50	1800
MFBM1V1005-090-R	5~13 Ω	9	0.05	100	50	1800
MFBM1V1005-110-R	7~15 Ω	11	0.05	100	50	1800
MFBM1V1005-150-R	9~21 Ω	15	0.05	100	50	1800
MFBM1V1005-190-R	12~25 Ω	19	0.06	100	50	1500
MFBM1V1005-300-R	±25%	30	0.08	100	50	1300
MFBM1V1005-600-R	±25%	60	0.10	100	50	1000
MFBM1V1005-700-R	±25%	70	0.15	100	50	800
MFBM1V1005-800-R	±25%	80	0.15	100	50	800
MFBM1V1005-101-R	±25%	100	0.15	100	50	800
MFBM1V1005-121-R	±25%	120	0.15	100	50	800
MFBM1V1005-151-R	±25%	150	0.20	100	50	700
MFBM1V1005-201-R	±25%	200	0.25	100	50	700
MFBM1V1005-221-R	±25%	220	0.30	100	50	600
MFBM1V1005-301-R	±25%	300	0.30	100	50	600
MFBM1V1005-501-R	±25%	500	0.40	100	50	500
MFBM1V1005-601-R	±25%	600	0.50	100	50	500
MFBM1V1005-801-R	±25%	800	0.65	100	50	300
MFBM1V1005-102-R	±25%	1000	0.65	100	50	300

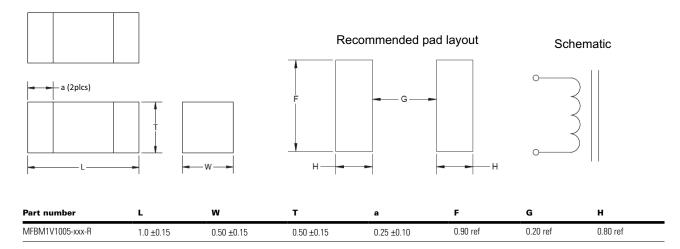
^{1.} Impedance test frequency and voltage.

MFBM1V1005 = Product code and size

 $\mbox{xxx} = \mbox{Impedance}$ value in $\Omega,$ last character equals number of zeros

-R suffix = RoHS compliant

Mechanical parameters, schematic, pad layout (mm)



Part marking: No marking All soldering surfaces to be coplanar within 0.1 millimeters Tolerances are ±0.1 millimeters unless stated otherwise Pad layout dimensions are reference only Traces or vias underneath the inductor is not recommended

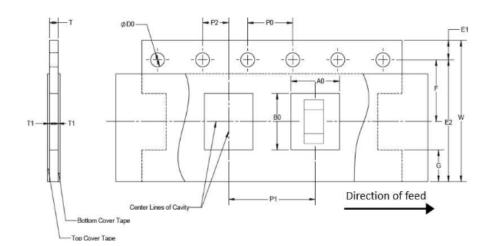
^{2.} Rated current: Current rating for an approximate self-temperature rise of 40 °C or less.

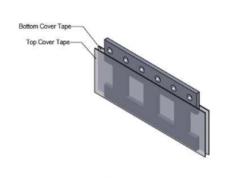
^{3.} Part number definition: MFBM1V1005-xxx-R

Packaging information (mm)

Drawing not to scale

Supplied in tape and reel packaging, 10000 parts per 7" diameter reel



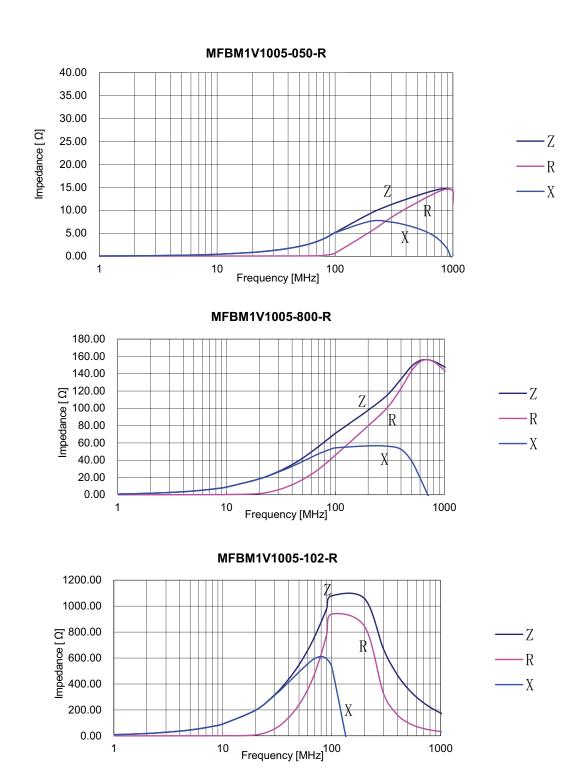


W±0.2	8.00
F±0.1	3.50
E1±0.2	1.75
E2 Min	na
P0±0.2	4.00
P1±0.2	2.00
P2±0.1	2.00
D0±0.1	1.55
A0	0.65±0.1
B0	1.15±0.1
Т	0.60±0.1
T1 Max	na

Qualification testing

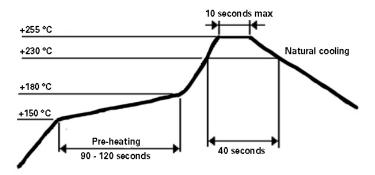
No.	Test item	Sample size (pcs)	Test condition	Acceptable value/range
1	External visual	72	Specification	No physical damage
2	Physical dimension	72	Specification	Specification
3	Initial electrical test	72	Specification	User specification
4	Solderability	6	+245 °C ±5 °C, dipping 5 ±1s	>95% solder coverage
5	Resistance to soldering heat	6	+260 ±5 °C for 10 ±1 s	1. ΔZ/Z<±30% 2. No physical damage
6	Terminal strength (SMD)	6	Force of 5N for 10 ±1 s	No physical damage No electrical performance test
7	Low temperature exposure	6	-55 °C for 1000 hours	1. ΔZ/Z<±30% 2. No physical damage
8	Bending strength	6	Appendix 2 note: 2 mm, hold time 30 s (minimum)	No physical damage No electrical performance test
9	Drop	6	Drop 10 times to a concrete floor from a height of 1 m	1. ΔZ/Z<±30% 2. No physical damage
10	Vibration	6	Amplitude modulation:1.5 mm Test time: A period of 2 hours in each of 3 mutually perpendicular directions Test from 10 Hz to 55 Hz to 10 Hz for 1 minute	1. ΔZ/Z<±30% 2. No physical damage
11	High temperature exposure	6	+125 °C for 1000 hours	1. ΔZ/Z<±30% 2. No physical damage
12	Biased humidity	6	1000 hours +60 °C/90% to 95% RH unpowered	1. ΔZ/Z<±30% 2. No physical damage
13	Operational life	12	+85 °C at rated current for 1000 hours	1. ΔZ/Z<±30% 2. No physical damage
14	Temperature cycling	6	32 cycles (-55 °C to +125 °C), dwell time 30 minutes	1. ΔZ/Z<±30% 2. No physical damage

Impedance vs frequency



Z= impedance, R= resistance, X= reactance

Solder reflow profile



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Electronics Division 1000 Eaton Boulevard Cleveland, OH 44122 United States Eaton.com/electronics

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